

# H110MLC Motherboard







- Support 6th Generation Intel® Core™ Processor
- Intel H110 single chip architecture
- Support 2-DIMM DDR4-2133/ 1866 up to 32G maximum capacity
- Support USB 3.0

## Specification

CPU SUPPORT	7th & 6th Gen Intel® Core™ i7 LGA 1151 Processor 7th & 6th Gen Intel® Core™ i5 LGA 1151 Processor 7th & 6th Gen Intel® Core™ i3 LGA 1151 Processor 7th & 6th Gen Intel® Pentium® LGA 1151 Processor 7th & 6th Gen Intel® Celeron® LGA 1151 Processor Maximum CPU TDP (Thermal Design Power) : 91Watt
MEMORY	Support Dual Channel DDR4 2133/ 1866 MHz 2 x DDR4 DIMM Memory Slot Max. Supports up to 32GB Memory
INTEGRATED VIDEO	By CPU model Supports DX12 Supports HDCP
STORAGE	4 x SATA III Connector
LAN	Realtek RTL8106E - 10/100 Controller
AUDIO CODEC	Realtek ALC887 8-Channel HD Audio
USB	2 x USB 3.0 Port 1 x USB 3.0 Header 2 x USB 2.0 Port 2 x USB 2.0 Header
EXPANSION SLOT	1 x PCI-E 3.0 x16 Slot 2 x PCI-E 2.0 x1 Slot
REAR I/O	1 x PS/2 Mouse 1 x PS/2 Keyboard 2 x USB 3.0 Port 2 x USB 2.0 Port 1 x VGA Port, resolution up to 1920 x 1200 @60Hz 1 x LAN Port 3 x Audio Jacks

INTERNAL I/O	<ul style="list-style-type: none"> <li>1 x USB 3.0 Header</li> <li>2 x USB 2.0 Header</li> <li>4 x SATA III Connector (6Gb/s)</li> <li>1 x Front Audio Header</li> <li>1 x Front Panel Header</li> <li>1 x CPU Fan Connector</li> <li>1 x System Fan Connector</li> <li>1 x COM Port Header</li> </ul>
H/W MONITORING	<ul style="list-style-type: none"> <li>CPU / System Temperature Monitoring</li> <li>CPU / System Fan Monitoring</li> <li>Smart / Manual CPU Fan Control</li> <li>System Voltage Monitoring</li> </ul>
DIMENSION	Micro ATX Form Factor Dimension: 22.6cm x 17.1cm ( W x L )
OS SUPPORT	Supports Windows 7 / 8.1(x64) / 10(x64)
BUNDLE SOFTWARE	<ul style="list-style-type: none"> <li>BullGuard</li> <li>BIO-Remote2</li> <li>Smart Speed LAN</li> </ul>
ACCESSORIES	<ul style="list-style-type: none"> <li>2 x SATA Cable</li> <li>1 x I/O Shield</li> <li>1 x DVD Driver</li> <li>1 x Quick Guide</li> </ul>
FEATURES	<ul style="list-style-type: none"> <li>Supports Solid capacitor</li> <li>Supports Charger Booster</li> <li>Supports BIOS Online Update</li> </ul>

## OVERVIEW

	<p><b>Intel H110 chipset</b></p> <p>The Intel® H110 chipset is a single-chipset design to support socket 1151 Intel® 6th generation Intel® Core™ processor-based platform. Provides excellent performance and increased bandwidth and stability. Intel® H110 chipset can also enable iGPU function, letting users enjoy the latest Intel® integrated graphic performance. The PC platform features improved adaptive performance that adds speed when you need it. When combined with advanced system responsiveness, the platform delivers the ultimate PC experience.</p>
	<p><b>HD Audio</b></p> <p>Provides high quality sound with minimal loss of audio fidelity.</p>
	<p><b>DX12</b></p> <p>DirectX 12 introduces the next version of Direct3D, the graphics API at the heart of DirectX. Direct3D is one of the most critical pieces of a game or game engine, and we've redesigned it to be faster and more efficient than ever before. Direct3D 12 enables richer scenes, more objects, and full utilization of modern GPU hardware.</p>
	<p><b>USB 3.0</b></p> <p>Experience Fastest data transfers at 5 Gbps with USB 3.0--the new latest connectivity standard. Built to connect easily with next-generation components and peripherals, USB 3.0 transfers data 10X faster and backward compatible with previous USB 2.0 components.</p>

	<h3>PCIe 3.0</h3> <p>PCIe 3.0 is the ubiquitous and general-purpose PCI Express I/O standard. At 8GT/s bit rate, the interconnect performance bandwidth is doubled over PCIe 2.0, while preserving compatibility with software and mechanical interfaces.</p>
	<h3>Moistureproof of PCB</h3> <p>The popularity of PC usage and working environment is getting deteriorating and moist (rural, coastal, etc.). The PCB will be oxidizing easily by damp or absorbed moisture, and ionic migration or CAF (Conductive Anodic Filament) will be generated. Moisture-proof PCB meets high density and high reliability requirements for moisture proof.</p>
	<h3>Low RdsOn P-Pak MOS</h3> <p>Low resistance design can significantly reduce the current out of energy loss. Low temperature, small size, excellent thermal conductivity.</p>
	<h3>Super Anti-Surge Protection</h3> <p>BIOSTAR exclusive Anti-Surge design provides the best protection of board and extends the product life. Having the latest model of "Transient Voltage Suppressor" on-board can effectively protect the board circuit, reducing the shocks caused by ESD as well as other damages arising from overvoltage transients to enhance system durability.</p>
	<h3>ESD Protection</h3> <p>ESD (Electrostatic Discharge) is the major factor to destroy the PC by electrical overstress (EOS) condition. ESD occurred by PC users when touch any devices connect to a PC, which may result in damage to the motherboard or parts. ESD protection is designed to protect the motherboard and equipment from damage by EOS.</p>
	<h3>USB Polyswitch</h3> <p>On board dedicated power fuse to help prevent USB port failure. It prevents USB Port overcurrent and safe guard your system and device lifespan.</p>
	<h3>OC / OV / OH Protection</h3> <p>OC / OV / OH Protection design detects overvoltage conditions and prevents voltage surges from spreading in real time. It also actively cuts off the overvoltage supply to protect your system.</p>
	<h3>Header Zone</h3> <p>Users can easily assemble their own computer, a simple-swap data discs and other accessories.</p>

\*The specification and pictures are subject to change without notice and the package contents may differ by area or your motherboard version!